# 74HC193; 74HCT193

Presettable synchronous 4-bit binary up/down counter

Rev. 6 — 5 February 2021 Product data sheet

### 1. General description

The 74HC193; 74HCT193 is a 4-bit synchronous binary up/down counter. Separate up/down clocks, CPU and CPD respectively, simplify operation. The outputs change state synchronously with the LOW-to-HIGH transition of either clock input. If the CPU clock is pulsed while CPD is held HIGH, the device will count up. If the CPD clock is pulsed while CPU is held HIGH, the device will count down. Only one clock input can be held HIGH at any time to guarantee predictable behavior. The device can be cleared at any time by the asynchronous master reset input (MR); it may also be loaded in parallel by activating the asynchronous parallel load input (PL). The terminal count up (TCU) and terminal count down (TCD) outputs are normally HIGH. When the circuit has reached the maximum count state of 15, the next HIGH-to-LOW transition of CPU will cause TCU to go LOW. TCU will stay LOW until CPU goes HIGH again, duplicating the count up clock. Likewise, the TCD output will go LOW when the circuit is in the zero state and the CPD goes LOW. The terminal count outputs can be used as the clock input signals to the next higher order circuit in a multistage counter, since they duplicate the clock waveforms. Multistage counters will not be fully synchronous, since there is a slight delay time difference added for each stage that is added. The counter may be preset by the asynchronous parallel load capability of the circuit. Information present on the parallel data inputs (D0 to D3) is loaded into the counter and appears on the outputs (Q0 to Q3) regardless of the conditions of the clock inputs when the parallel load (PL) input is LOW. A HIGH level on the master reset (MR) input will disable the parallel load gates, override both clock inputs and set all outputs (Q0 to Q3) LOW. If one of the clock inputs is LOW during and after a reset or load operation, the next LOW-to-HIGH transition of that clock will be interpreted as a legitimate signal and will be counted. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

#### 2. Features and benefits

- · Input levels:
  - For 74HC193: CMOS level
  - For 74HCT193: TTL level
- Synchronous reversible 4-bit binary counting
- Asynchronous parallel load
- Asynchronous reset
- Expandable without external logic
- Complies with JEDEC standard no. 7A
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

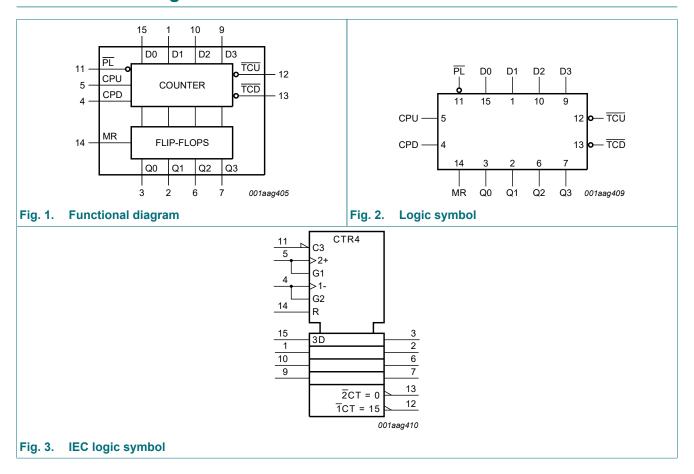


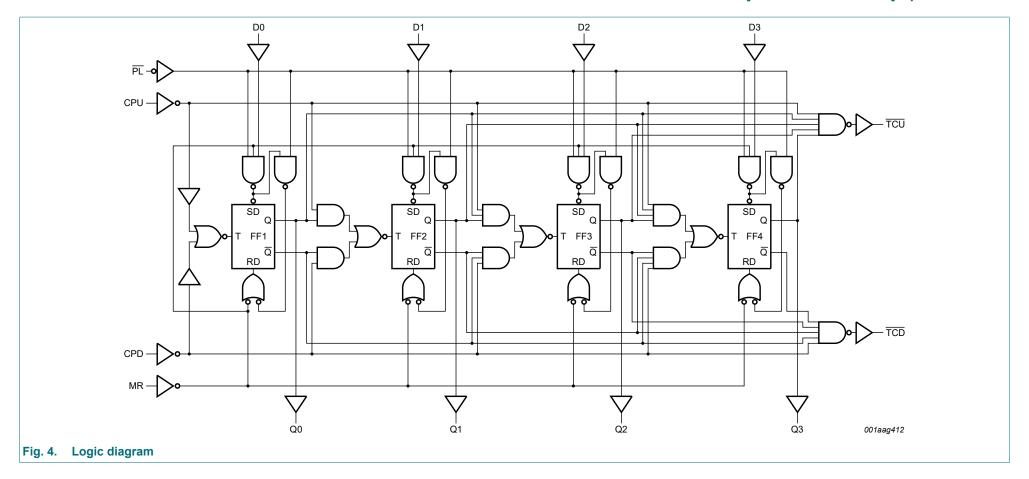
# 3. Ordering information

**Table 1. Ordering information** 

| Type number | Package           |         |   |          |
|-------------|-------------------|---------|---|----------|
|             | Temperature range | Name    | Description   | Version  |
| 74HC193D    | -40 °C to +125 °C | SO16    | plastic small outline package; 16 leads;                          | SOT109-1 |
| 74HCT193D   |                   |         | body width 3.9 mm   |          |
| 74HCT193DB  | -40 °C to +125 °C | SSOP16  | plastic shrink small outline package; 16 leads; body width 5.3 mm | SOT338-1 |
| 74HC193PW   | -40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads;              | SOT403-1 |
| 74HCT193PW  |                   |         | body width 4.4 mm   |          |

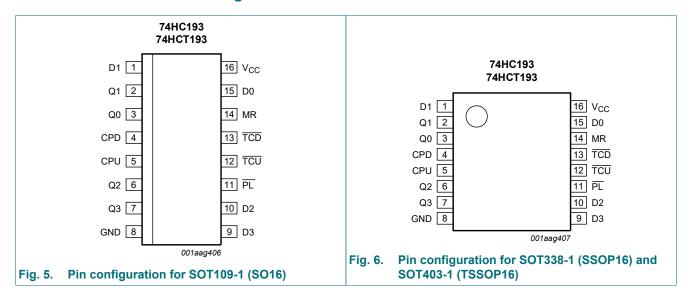
# 4. Functional diagram





# 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

| Symbol          | Pin          | Description   |
|-----------------|--------------|---|
| D0, D1, D2, D3  | 15, 1, 10, 9 | data input  |
| Q0, Q1, Q2, Q3  | 3, 2, 6, 7   | flip-flop output                                    |
| CPD             | 4            | count down clock input; LOW-to-HIGH, edge triggered |
| CPU             | 5            | count up clock input; LOW-to-HIGH, edge triggered   |
| GND             | 8            | ground (0 V)  |
| PL              | 11           | asynchronous parallel load input (active LOW)       |
| TCU             | 12           | terminal count up (carry) output (active LOW)       |
| TCD             | 13           | terminal count down (borrow) output (active LOW)    |
| MR              | 14           | asynchronous master reset input (active HIGH)       |
| V <sub>CC</sub> | 16           | supply voltage                                      |

# 6. Functional description

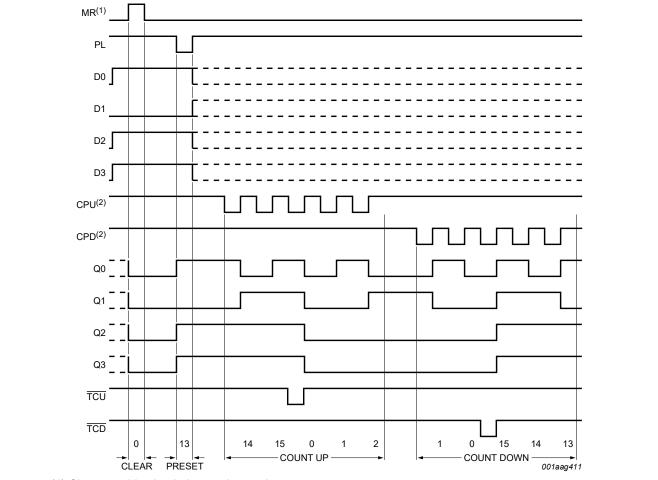
#### Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ \uparrow = LOW-to-HIGH \ clock \ transition.$ 

| Operating mode | Input | s  |     |     |    |    |    |    | Outp  | uts  |    |    |       |       |
|----------------|-------|----|-----|-----|----|----|----|----|-------|------|----|----|-------|-------|
|                | MR    | PL | CPU | CPD | D0 | D1 | D2 | D3 | Q0    | Q1   | Q2 | Q3 | TCU   | TCD   |
| Reset (clear)  | Н     | Х  | Х   | L   | Х  | Х  | Х  | Х  | L     | L    | L  | L  | Н     | L     |
|                | Н     | Х  | Х   | Н   | Х  | Х  | Х  | Х  | L     | L    | L  | L  | Н     | Н     |
| Parallel load  | L     | L  | Х   | L   | L  | L  | L  | L  | L     | L    | L  | L  | Н     | L     |
|                | L     | L  | Х   | Н   | L  | L  | L  | L  | L     | L    | L  | L  | Н     | Н     |
|                | L     | L  | L   | Х   | Н  | Н  | Н  | Н  | Н     | Н    | Н  | Н  | L     | Н     |
|                | L     | L  | Н   | Х   | Н  | Н  | Н  | Н  | Н     | Н    | Н  | Н  | Н     | Н     |
| Count up       | L     | Н  | 1   | Н   | Х  | Х  | Х  | Х  | count | up   |    |    | H [1] | Н     |
| Count down     | L     | Н  | Н   | 1   | Х  | Χ  | Х  | Х  | count | down |    |    | Н     | H [2] |

<sup>[1]</sup> TCU = CPU at terminal count up (HHHH)

<sup>[2]</sup> TCD = CPD at terminal count down (LLLL).



- (1) Clear overrides load, data and count inputs.
- (2) When counting up, the count down clock input (CPD) must be HIGH, when counting down the count up clock input (CPU) must be HIGH.

#### Sequence:

Clear (reset outputs to zero);

Load (preset) to binary thirteen;

Count up to fourteen, fifteen, terminal count up, zero, one and two;

Count down to one, zero, terminal count down, fifteen, fourteen and thirteen.

Fig. 7. Typical clear, load and count sequence

# 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions  |     | Min  | Max  | Unit |
|------------------|-------------------------|---|-----|------|------|------|
| $V_{CC}$         | supply voltage          |   |     | -0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ | [1] | -    | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current | $V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V              | [1] | -    | ±20  | mA   |
| Io               | output current          | $V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$         |     | -    | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |   |     | -    | 50   | mA   |
| I <sub>GND</sub> | ground current          |   |     | -    | -50  | mA   |
| T <sub>stg</sub> | storage temperature     |   |     | -65  | +150 | °C   |
| P <sub>tot</sub> | total power dissipation |   | [2] | -    | 500  | mW   |

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT338-1 (SSOP16) package: Ptot derates linearly with 8.5 mW/K above 91 °C.

For SOT403-1 (TSSOP16) package: Ptot derates linearly with 8.5 mW/K above 91 °C.

# 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol           | Parameter                           | Conditions              |     | 74HC193 | 3               | 7   | 74HCT19 | 3               | Unit |
|------------------|-------------------------------------|-------------------------|-----|---------|-----------------|-----|---------|-----------------|------|
|                  |                                     |                         | Min | Тур     | Max             | Min | Тур     | Max             |      |
| V <sub>CC</sub>  | supply voltage                      |                         | 2.0 | 5.0     | 6.0             | 4.5 | 5.0     | 5.5             | V    |
| VI               | input voltage                       |                         | 0   | -       | V <sub>CC</sub> | 0   | -       | V <sub>CC</sub> | V    |
| Vo               | output voltage                      |                         | 0   | -       | V <sub>CC</sub> | 0   | -       | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                         | -40 | +25     | +125            | -40 | +25     | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 2.0 V | -   | -       | 625             | -   | -       | -               | ns/V |
|                  |                                     | V <sub>CC</sub> = 4.5 V | -   | 1.67    | 139             | -   | 1.67    | 139             | ns/V |
|                  |                                     | V <sub>CC</sub> = 6.0 V | -   | -       | 83              | -   | -       | -               | ns/V |

<sup>[2]</sup> For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C.

# 9. Static characteristics

#### Table 6. Static characteristics type 74HC193

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                | Parameter             | Conditions   | Min  | Тур  | Max  | Unit |
|-----------------------|-----------------------|--|------|------|------|------|
| T <sub>amb</sub> = 25 | °C                    |  |      |      |      |      |
| V <sub>IH</sub>       | HIGH-level input      | V <sub>CC</sub> = 2.0 V                              | 1.5  | 1.2  | -    | V    |
|                       | voltage               | V <sub>CC</sub> = 4.5 V                              | 3.15 | 2.4  | -    | V    |
|                       |                       | V <sub>CC</sub> = 6.0 V                              | 4.2  | 3.2  | -    | V    |
| V <sub>IL</sub>       | LOW-level input       | V <sub>CC</sub> = 2.0 V                              | -    | 0.8  | 0.5  | V    |
|                       | voltage               | V <sub>CC</sub> = 4.5 V                              | -    | 2.1  | 1.35 | V    |
|                       |                       | V <sub>CC</sub> = 6.0 V                              | -    | 2.8  | 1.8  | V    |
| V <sub>OH</sub>       | HIGH-level output     | $V_I = V_{IH}$ or $V_{IL}$                           | -    | -    | -    |      |
|                       | voltage               | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V     | 1.9  | 2.0  | -    | V    |
|                       |                       | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V     | 4.4  | 4.5  | -    | V    |
|                       |                       | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V     | 5.9  | 6.0  | -    | V    |
|                       |                       | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V    | 3.98 | 4.32 | -    | V    |
|                       |                       | I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V    | 5.48 | 5.81 | -    | V    |
| V <sub>OL</sub>       | LOW-level output      | $V_I = V_{IH}$ or $V_{IL}$                           |      |      |      |      |
|                       | voltage               | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V      | -    | 0    | 0.1  | V    |
|                       |                       | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V      | -    | 0    | 0.1  | V    |
|                       |                       | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V      | -    | 0    | 0.1  | V    |
|                       |                       | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V     | -    | 0.15 | 0.26 | V    |
|                       |                       | I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V     | -    | 0.16 | 0.26 | V    |
| l <sub>l</sub>        | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$      | -    | -    | ±0.1 | μΑ   |
| I <sub>CC</sub>       | supply current        | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V | -    | -    | 8.0  | μΑ   |
| C <sub>i</sub>        | input capacitance     |  | -    | 3.5  | -    | pF   |

| Symbol                 | Parameter             | Conditions   | Min  | Тур | Max  | Unit     |
|------------------------|-----------------------|--|------|-----|------|----------|
| T <sub>amb</sub> = -40 | ) °C to +85 °C        |  |      |     |      |          |
| V <sub>IH</sub>        | HIGH-level input      | V <sub>CC</sub> = 2.0 V                              | 1.5  | -   | -    | V        |
|                        | voltage               | V <sub>CC</sub> = 4.5 V                              | 3.15 | -   | -    | V        |
|                        |                       | V <sub>CC</sub> = 6.0 V                              | 4.2  | -   | -    | V        |
| V <sub>IL</sub>        | LOW-level input       | V <sub>CC</sub> = 2.0 V                              | -    | -   | 0.5  | V        |
|                        | voltage               | V <sub>CC</sub> = 4.5 V                              | -    | -   | 1.35 | V        |
|                        |                       | V <sub>CC</sub> = 6.0 V                              | -    | -   | 1.8  | V        |
| V <sub>OH</sub>        | HIGH-level output     | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>  |      |     |      |          |
|                        | voltage               | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V     | 1.9  | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V     | 4.4  | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V     | 5.9  | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V    | 3.84 | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V    | 5.34 | -   | -    | V        |
| V <sub>OL</sub>        | LOW-level output      | $V_I = V_{IH}$ or $V_{IL}$                           |      |     |      |          |
|                        | voltage               | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V      | -    | -   | 0.1  | V        |
|                        |                       | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V      | -    | -   | 0.1  | V        |
|                        |                       | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V      | -    | -   | 0.1  | V        |
|                        |                       | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V     | -    | -   | 0.33 | V        |
|                        |                       | I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V     | -    | -   | 0.33 | V        |
| l <sub>I</sub>         | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$      | -    | -   | ±1.0 | μA       |
| lcc                    | supply current        | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V | -    | -   | 80   | μA       |
| T <sub>amb</sub> = -40 | ) °C to +125 °C       |  | '    | •   | '    | <u>'</u> |
| V <sub>IH</sub>        | HIGH-level input      | V <sub>CC</sub> = 2.0 V                              | 1.5  | -   | -    | V        |
|                        | voltage               | V <sub>CC</sub> = 4.5 V                              | 3.15 | -   | -    | V        |
|                        |                       | V <sub>CC</sub> = 6.0 V                              | 4.2  | -   | -    | V        |
| V <sub>IL</sub>        | LOW-level input       | V <sub>CC</sub> = 2.0 V                              | -    | -   | 0.5  | V        |
|                        | voltage               | V <sub>CC</sub> = 4.5 V                              | -    | -   | 1.35 | V        |
|                        |                       | V <sub>CC</sub> = 6.0 V                              | -    | -   | 1.8  | V        |
| V <sub>OH</sub>        | HIGH-level output     | $V_I = V_{IH}$ or $V_{IL}$                           |      |     |      |          |
|                        | voltage               | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V     | 1.9  | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V     | 4.4  | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V     | 5.9  | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V    | 3.7  | -   | -    | V        |
|                        |                       | I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V    | 5.2  | -   | -    | V        |
| V <sub>OL</sub>        | LOW-level output      | $V_I = V_{IH}$ or $V_{IL}$                           |      |     |      |          |
|                        | voltage               | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V      | -    | -   | 0.1  | V        |
|                        |                       | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V      | -    | -   | 0.1  | V        |
|                        |                       | I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V      | -    | -   | 0.1  | V        |
|                        |                       | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V     | -    | -   | 0.4  | V        |
|                        |                       | I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V     | -    | -   | 0.4  | V        |
| l <sub>l</sub>         | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$      | -    | -   | ±1.0 | μA       |
| I <sub>CC</sub>        | supply current        | $V_1 = V_{CC}$ or GND; $I_0 = 0$ A; $V_{CC} = 6.0$ V | -    | -   | 160  | μA       |

Table 7. Static characteristics type 74HCT193

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                 | Parameter                 | Conditions   | Min  | Тур  | Max   | Unit |
|------------------------|---------------------------|--|------|------|-------|------|
| T <sub>amb</sub> = 25  |                           |  |      |      |       |      |
| V <sub>IH</sub>        |                           | V <sub>CC</sub> = 4.5 V to 5.5 V   | 2.0  | 1.6  | -     | V    |
| V <sub>IL</sub>        | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V   | -    | 1.2  | 0.8   | V    |
| V <sub>OH</sub>        | HIGH-level output         | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |      |      |       |      |
|                        | voltage                   | I <sub>O</sub> = -20 μA  | 4.4  | 4.5  | -     | V    |
|                        |                           | I <sub>O</sub> = -4.0 mA   | 3.98 | 4.32 | -     | V    |
| V <sub>OL</sub>        | LOW-level output          | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |      |      |       |      |
|                        | voltage                   | Ι <sub>Ο</sub> = 20 μΑ   | -    | 0    | 0.1   | V    |
|                        |                           | I <sub>O</sub> = 4.0 mA  | -    | 0.15 | 0.26  | V    |
| l <sub>l</sub>         | input leakage current     | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$  | -    | -    | ±0.1  | μA   |
| I <sub>cc</sub>        | supply current            | $V_1 = V_{CC}$ or GND; $I_0 = 0$ A; $V_{CC} = 5.5$ V   | -    | -    | 8.0   | μA   |
| ΔI <sub>CC</sub>       | additional supply current | per input pin; $V_I = V_{CC}$ - 2.1 V; other inputs at $V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V |      |      |       |      |
|                        |                           | pin Dn   | -    | 35   | 126   | μΑ   |
|                        |                           | pins CPU, CPD  | -    | 140  | 504   | μΑ   |
|                        |                           | pin PL   | -    | 65   | 234   | μΑ   |
|                        |                           | pin MR   | -    | 105  | 378   | μΑ   |
| C <sub>i</sub>         | input capacitance         |  | -    | 3.5  | -     | pF   |
| T <sub>amb</sub> = -40 | °C to +85 °C              |  |      | ,    |       | '    |
| V <sub>IH</sub>        | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V   | 2.0  | -    | -     | V    |
| V <sub>IL</sub>        | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V   | -    | -    | 0.8   | V    |
| V <sub>OH</sub>        | HIGH-level output         | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |      |      |       |      |
|                        | voltage                   | I <sub>O</sub> = -20 μA  | 4.4  | -    | -     | V    |
|                        |                           | I <sub>O</sub> = -4.0 mA   | 3.84 | -    | -     | V    |
| V <sub>OL</sub>        | LOW-level output          | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |      |      |       |      |
|                        | voltage                   | Ι <sub>Ο</sub> = 20 μΑ   | -    | -    | 0.1   | V    |
|                        |                           | I <sub>O</sub> = 4.0 mA  | -    | -    | 0.33  | V    |
| l <sub>I</sub>         | input leakage current     | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$  | -    | -    | ±1.0  | μA   |
| lcc                    | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V   | -    | -    | 80    | μA   |
| ΔI <sub>CC</sub>       | additional supply current | per input pin; $V_I = V_{CC}$ - 2.1 V; other inputs at $V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V |      |      |       |      |
|                        |                           | pin Dn   | -    | -    | 157.5 | μΑ   |
|                        |                           | pins CPU, CPD  | -    | -    | 630   | μΑ   |
|                        |                           | pin PL   | -    | -    | 292.5 | μΑ   |
|                        |                           | pin MR   | -    | -    | 472.5 | μA   |

| Symbol                 | Parameter                 | Conditions   | Min | Тур | Max   | Unit |
|------------------------|---------------------------|--|-----|-----|-------|------|
| T <sub>amb</sub> = -40 | °C to +125 °C             |  |     |     |       |      |
| V <sub>IH</sub>        | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V   | 2.0 | -   | -     | V    |
| V <sub>IL</sub>        | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V   | -   | -   | 0.8   | V    |
| V <sub>OH</sub>        | HIGH-level output         | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |     |     |       |      |
|                        | voltage                   | I <sub>O</sub> = -20 μA  | 4.4 | -   | -     | V    |
|                        |                           | I <sub>O</sub> = -4.0 mA   | 3.7 | -   | -     | V    |
| V <sub>OL</sub>        | LOW-level output          | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |     |     |       |      |
|                        | voltage                   | I <sub>O</sub> = 20 μA   | -   | -   | 0.1   | V    |
|                        |                           | I <sub>O</sub> = 4.0 mA  | -   | -   | 0.4   | V    |
| l <sub>l</sub>         | input leakage current     | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$  | -   | -   | ±1.0  | μΑ   |
| I <sub>CC</sub>        | supply current            | $V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 5.5$ V   | -   | -   | 160   | μΑ   |
| ΔI <sub>CC</sub>       | additional supply current | per input pin; $V_I = V_{CC}$ - 2.1 V; other inputs at $V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V |     |     |       |      |
|                        |                           | pin Dn   | -   | -   | 171.5 | μΑ   |
|                        |                           | pins CPU, CPD  | -   | -   | 686   | μΑ   |
|                        |                           | pin PL   | -   | -   | 318.5 | μΑ   |
|                        |                           | pin MR   | -   | -   | 514.5 | μA   |

# 10. Dynamic characteristics

|    | Parameter   | acteristics type 74HC193 Conditions  |     | 25 °C |     | -40 °C t | o +85 °C | -40 °C to | +125 °C | Unit |
|----|-------------|--------------------------------------|-----|-------|-----|----------|----------|-----------|---------|------|
|    |             |                                      | Min | Тур   | Max | Min      | Max      | Min       | Max     | 1    |
| pd | propagation | CPU, CPD to Qn; see Fig. 8 [1]       | -   |       |     |          |          |           |         |      |
|    | delay       | V <sub>CC</sub> = 2.0 V              | -   | 63    | 215 | -        | 270      | -         | 325     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 23    | 43  | -        | 54       | -         | 65      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | -   | 18    | 37  | -        | 46       | -         | 55      | ns   |
|    |             | CPU to TCU; see Fig. 9               |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 39    | 125 | -        | 155      | -         | 190     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 14    | 25  | -        | 31       | -         | 38      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | -   | 11    | 21  | -        | 26       | -         | 32      | ns   |
|    |             | CPD to TCD; see Fig. 9               |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 39    | 125 | -        | 155      | -         | 190     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 14    | 25  | -        | 31       | -         | 38      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | -   | 11    | 21  | -        | 26       | -         | 32      | ns   |
|    |             | PL to Qn; see Fig. 10                |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 69    | 220 | -        | 275      | -         | 330     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 25    | 44  | -        | 55       | -         | 66      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | _   | 20    | 37  | -        | 47       | -         | 56      | ns   |
|    |             | MR to Qn; see Fig. 11                |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 58    | 200 | -        | 250      | -         | 300     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 21    | 40  | -        | 50       | -         | 60      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | -   | 17    | 34  |          | 43       | -         | 51      | ns   |
|    |             | Dn to Qn; see Fig. 10                |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 69    | 210 | -        | 265      | -         | 315     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 25    | 42  | -        | 53       | -         | 63      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | -   | 20    | 36  | -        | 45       | -         | 54      | ns   |
|    |             | PL to TCU, PL to TCD;<br>see Fig. 13 |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 80    | 290 | -        | 365      | -         | 435     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 29    | 58  | -        | 73       | -         | 87      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | -   | 23    | 49  | -        | 62       | -         | 74      | ns   |
|    |             | MR to TCU, MR to TCD;<br>see Fig. 13 |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 74    | 285 | -        | 355      | -         | 430     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 27    | 57  | -        | 71       | -         | 86      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | -   | 22    | 48  | -        | 60       | -         | 73      | ns   |
|    |             | Dn to TCU, Dn to TCD;<br>see Fig. 13 |     |       |     |          |          |           |         |      |
|    |             | V <sub>CC</sub> = 2.0 V              | -   | 80    | 290 | -        | 365      | -         | 435     | ns   |
|    |             | V <sub>CC</sub> = 4.5 V              | -   | 29    | 58  | -        | 73       | -         | 87      | ns   |
|    |             | V <sub>CC</sub> = 6.0 V              | _   | 23    | 49  | -        | 62       | _         | 74      | ns   |

| Symbol           | Parameter              | Conditions                                 |     | 25 °C |     | -40 °C t | o +85 °C | -40 °C to | +125 °C | Unit |
|------------------|------------------------|--|-----|-------|-----|----------|----------|-----------|---------|------|
|                  |                        |  | Min | Тур   | Max | Min      | Max      | Min       | Max     |      |
| t <sub>THL</sub> | HIGH to LOW            | see Fig. 11                                |     |       |     |          |          |           |         |      |
|                  | output transition time | V <sub>CC</sub> = 2.0 V                    | -   | 19    | 75  | -        | 95       | -         | 110     | ns   |
|                  | transition time        | V <sub>CC</sub> = 4.5 V                    | -   | 7     | 15  | -        | 19       | -         | 22      | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | -   | 6     | 13  | -        | 16       | -         | 19      | ns   |
| t <sub>TLH</sub> | LOW to HIGH            | see Fig. 11                                |     |       |     |          |          |           |         |      |
|                  | output transition time | V <sub>CC</sub> = 2.0 V                    | -   | 19    | 75  | -        | 95       | -         | 110     | ns   |
|                  | transition time        | V <sub>CC</sub> = 4.5 V                    | -   | 7     | 15  | -        | 19       | -         | 22      | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | -   | 6     | 13  | -        | 16       | -         | 19      | ns   |
| t <sub>W</sub>   | pulse width            | CPU, CPD; HIGH or LOW; see Fig. 8          |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 100 | 22    | -   | 125      | -        | 150       | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 20  | 8     | -   | 25       | -        | 30        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 17  | 6     | -   | 21       | -        | 26        | -       | ns   |
|                  |                        | MR HIGH; see Fig. 11                       |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 100 | 25    | -   | 125      | -        | 150       | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 20  | 9     | -   | 25       | -        | 30        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 17  | 7     | -   | 21       | -        | 26        | -       | ns   |
|                  |                        | PL LOW; see Fig. 10                        |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 100 | 19    | -   | 125      | -        | 150       | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 20  | 7     | -   | 25       | -        | 30        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 17  | 6     | -   | 21       | -        | 26        | -       | ns   |
| rec              | recovery time          | PL to CPU, CPD; see Fig. 10                |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 50  | 8     | -   | 65       | -        | 75        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 10  | 3     | -   | 13       | -        | 15        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 9   | 2     | -   | 11       | -        | 13        | -       | ns   |
|                  |                        | MR to CPU, CPD;<br>see Fig. 11             |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 50  | 0     | -   | 65       | -        | 75        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 10  | 0     | -   | 13       | -        | 15        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 9   | 0     | -   | 11       | -        | 13        | -       | ns   |
| t <sub>su</sub>  | set-up time            | Dn to PL; see Fig. 12;<br>CPU = CPD = HIGH |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 80  | 22    | -   | 100      | -        | 120       | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 16  | 8     | -   | 20       | -        | 24        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 14  | 6     | -   | 17       | -        | 20        | -       | ns   |
| h                | hold time              | Dn to PL; see Fig. 12                      |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 0   | -14   | -   | 0        | -        | 0         | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 0   | -5    | -   | 0        | -        | 0         | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 0   | -4    | -   | 0        |          | 0         | -       | ns   |
|                  |                        | CPU to CPD, CPD to CPU; see Fig. 14        |     |       |     |          |          |           |         |      |
|                  |                        | V <sub>CC</sub> = 2.0 V                    | 80  | 22    | -   | 100      | -        | 120       | -       | ns   |
|                  |                        | V <sub>CC</sub> = 4.5 V                    | 16  | 8     | -   | 20       | -        | 24        | -       | ns   |
|                  |                        | V <sub>CC</sub> = 6.0 V                    | 8   | 6     | -   | 17       | -        | 20        | -       | ns   |

| Symbol           | Parameter                           | Conditions  |     | 25 °C |     | -40 °C to | +85 °C | -40 °C to | +125 °C | Unit |
|------------------|-------------------------------------|---|-----|-------|-----|-----------|--------|-----------|---------|------|
|                  |                                     |   | Min | Тур   | Max | Min       | Max    | Min       | Max     |      |
| f <sub>max</sub> | maximum                             | CPU, CPD; see Fig. 8  |     |       |     |           |        |           |         |      |
|                  | frequency                           | V <sub>CC</sub> = 2.0 V                                     | 4.0 | 13.5  | -   | 3.2       | -      | 2.6       | -       | MHz  |
|                  |                                     | V <sub>CC</sub> = 4.5 V                                     | 20  | 41    | -   | 16        | -      | 13        | -       | MHz  |
|                  |                                     | V <sub>CC</sub> = 6.0 V                                     | 24  | 49    | -   | 19        | -      | 15        | -       | MHz  |
| C <sub>PD</sub>  | power<br>dissipation<br>capacitance | $V_I$ = GND to $V_{CC}$ ; $V_{CC}$ = 5 V; [2] $f_i$ = 1 MHz | -   | 24    | -   | -         | -      | -         | -       | pF   |

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs}.$ 

#### Table 9. Dynamic characteristics type 74HCT193

| Symbol           | Parameter                 | Conditions                           |   | 25 °C |     | -40 °C t | o +85 °C | -40 °C to +125 °C |     | Unit |
|------------------|---------------------------|--------------------------------------|---|-------|-----|----------|----------|-------------------|-----|------|
|                  |                           |                                      |   | Тур   | Max | Min      | Max      | Min               | Max |      |
| t <sub>pd</sub>  | propagation               | CPU, CPD to Qn; see Fig. 8 [1]       |   |       |     |          |          |                   |     |      |
|                  | delay                     | V <sub>CC</sub> = 4.5 V              | - | 23    | 43  | -        | 54       | -                 | 65  | ns   |
|                  |                           | CPU to TCU; see Fig. 9               |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 15    | 27  | -        | 34       | -                 | 41  | ns   |
|                  |                           | CPD to TCD; see Fig. 9               |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 15    | 27  | -        | 34       | -                 | 41  | ns   |
|                  |                           | PL to Qn; see Fig. 10                |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 26    | 46  | -        | 58       | -                 | 69  | ns   |
|                  |                           | MR to Qn; see Fig. 11                |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 22    | 40  | -        | 50       | -                 | 60  | ns   |
|                  |                           | Dn to Qn; see Fig. 10                |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 27    | 46  | -        | 58       | -                 | 69  | ns   |
|                  |                           | PL to TCU, PL to TCD;<br>see Fig. 13 |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 31    | 55  | -        | 69       | -                 | 83  | ns   |
|                  |                           | MR to TCU, MR to TCD;<br>see Fig. 13 |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 29    | 55  | -        | 69       | -                 | 83  | ns   |
|                  |                           | Dn to TCU, Dn to TCD;<br>see Fig. 13 |   |       |     |          |          |                   |     |      |
|                  |                           | V <sub>CC</sub> = 4.5 V              | - | 32    | 58  | -        | 73       | -                 | 87  | ns   |
| t <sub>THL</sub> | HIGH to LOW               | see Fig. 11                          |   |       |     |          |          |                   |     |      |
|                  | output<br>transition time | V <sub>CC</sub> = 4.5 V              | - | 7     | 15  | -        | 19       | -                 | 22  | ns   |
| t <sub>TLH</sub> | LOW to HIGH               | see Fig. 11                          |   |       |     |          |          |                   |     |      |
|                  | output<br>transition time | V <sub>CC</sub> = 4.5 V              | - | 7     | 15  | -        | 19       | -                 | 22  | ns   |

| Symbol                   | Parameter                           | Conditions  |     | 25 °C |     | -40 °C to +85 °C |     | -40 °C to +125 °C |     | Unit |
|--------------------------|-------------------------------------|---|-----|-------|-----|------------------|-----|-------------------|-----|------|
|                          |                                     |   | Min | Тур   | Max | Min              | Max | Min               | Max |      |
| t <sub>W</sub>           | pulse width                         | CPU, CPD; HIGH or LOW; see Fig. 8   |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 25  | 11    | -   | 31               | -   | 38                | -   | ns   |
|                          |                                     | MR HIGH; see Fig. 11  |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 20  | 7     | -   | 25               | -   | 30                | -   | ns   |
|                          |                                     | PL LOW; see Fig. 10   |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 20  | 8     | -   | 25               | -   | 30                | -   | ns   |
| t <sub>rec</sub>         | recovery time                       | PL to CPU, CPD; see Fig. 10   |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 10  | 2     | -   | 13               | -   | 15                | -   | ns   |
|                          |                                     | MR to CPU, CPD;<br>see Fig. 11  |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 10  | 0     | -   | 13               | -   | 15                | -   | ns   |
| t <sub>su</sub>          | set-up time                         | Dn to PL; see Fig. 12;<br>CPU = CPD = HIGH  |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 16  | 8     | -   | 20               | -   | 24                | -   | ns   |
| t <sub>h</sub>           | hold time                           | Dn to PL; see Fig. 12   |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 0   | -6    | -   | 0                | -   | 0                 | -   | ns   |
|                          |                                     | CPU to CPD, CPD to CPU; see Fig. 14   |     |       |     |                  |     |                   |     |      |
|                          |                                     | V <sub>CC</sub> = 4.5 V   | 16  | 7     | -   | 20               | -   | 24                | -   | ns   |
| f <sub>max</sub> maximum |                                     | CPU, CPD; see Fig. 8  |     |       |     |                  |     |                   |     |      |
|                          | frequency                           | V <sub>CC</sub> = 4.5 V   | 20  | 43    | -   | 16               | -   | 13                | -   | MHz  |
| C <sub>PD</sub>          | power<br>dissipation<br>capacitance | $V_I = GND \text{ to } V_{CC} - 1.5 \text{ V};$ [2] $V_{CC} = 5 \text{ V}; f_i = 1 \text{ MHz}$ | -   | 26    | -   | -                | -   | -                 | -   | pF   |

 $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W):  $P_D = C_{PD} \ x \ V_{CC}^2 \ x \ f_i \ x \ N + \Sigma (C_L \ x \ V_{CC}^2 \ x \ f_o)$  where:

 $f_i$  = input frequency in MHz;

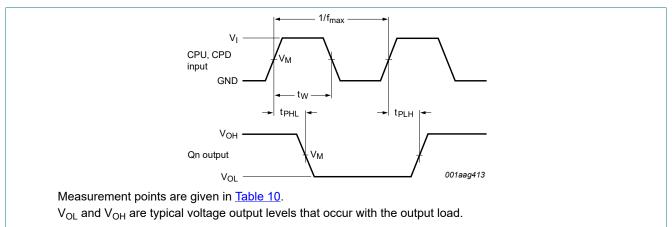
f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

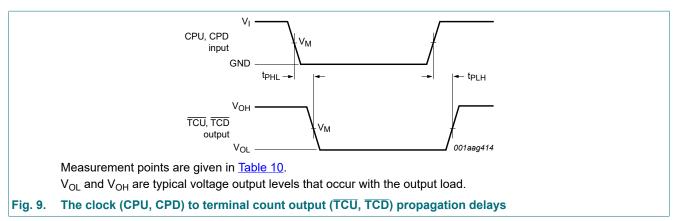
 $V_{CC}$  = supply voltage in V;

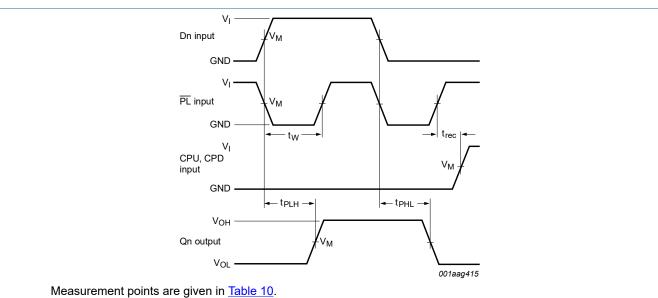
N = number of inputs switching;  $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

#### 10.1. Waveforms and test circuit



The clock (CPU, CPD) to output (Qn) propagation delays, the clock pulse width, and the maximum clock Fig. 8. pulse frequency

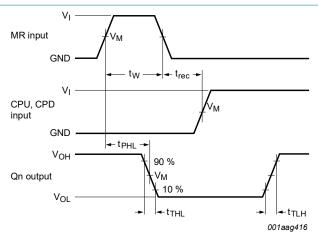




V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 10. The parallel load input (PL) and data (Dn) to Qn output propagation delays and PL removal time to clock input (CPU, CPD)

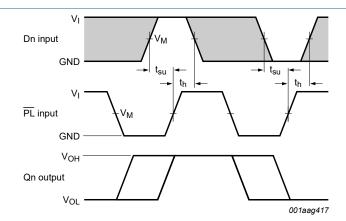
74HC\_HCT193



Measurement points are given in <u>Table 10</u>.

V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 11. The master reset input (MR) pulse width, MR to Qn propagation delays, MR to CPU, CPD removal time and output transition times

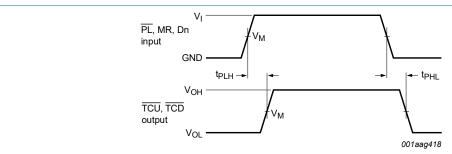


Measurement points are given in Table 10.

 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

The shaded areas indicate when the input is permitted to change for predictable output performance.

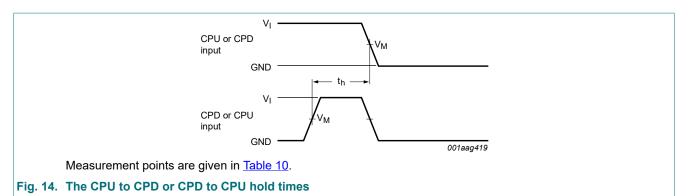
Fig. 12. The data input (Dn) to parallel load input (PL) set-up and hold times



Measurement points are given in Table 10.

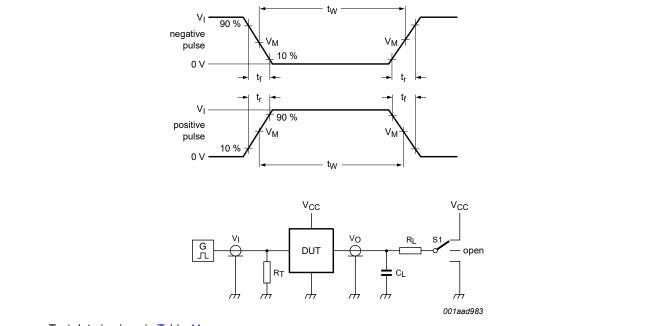
V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig. 13. The data input (Dn), parallel load input (PL) and the master reset input (MR) to the terminal count outputs (TCU, TCD) propagation delays



**Table 10. Measurement points** 

| Туре     | Input                 | Output                 |                       |
|----------|-----------------------|------------------------|-----------------------|
|          | V <sub>M</sub>        | V <sub>I</sub>         | V <sub>M</sub>        |
| 74HC193  | 0.5 × V <sub>CC</sub> | GND to V <sub>CC</sub> | 0.5 × V <sub>CC</sub> |
| 74HCT193 | 1.3 V                 | GND to 3 V             | 1.3 V                 |



Test data is given in Table 11.

Definitions test circuit:

 $R_{T}$  = Termination resistance should be equal to output impedance  $Z_{o}$  of the pulse generator

C<sub>L</sub> = Load capacitance including jig and probe capacitance

R<sub>L</sub> = Load resistor

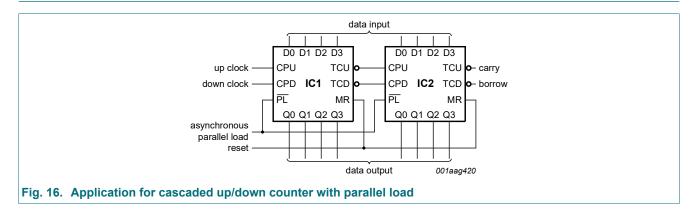
S1 = Test selection switch

Fig. 15. Test circuit for measuring switching times

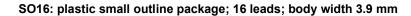
Table 11. Test data

| Туре     | Input           |                                 | Load         | S1 position |                                     |  |  |  |
|----------|-----------------|---------------------------------|--------------|-------------|-------------------------------------|--|--|--|
|          | VI              | t <sub>r</sub> , t <sub>f</sub> | CL           | $R_L$       | t <sub>PHL</sub> , t <sub>PLH</sub> |  |  |  |
| 74HC193  | V <sub>CC</sub> | 6 ns                            | 15 pF, 50 pF | 1 kΩ        | open                                |  |  |  |
| 74HCT193 | 3 V             | 6 ns                            | 15 pF, 50 pF | 1 kΩ        | open                                |  |  |  |

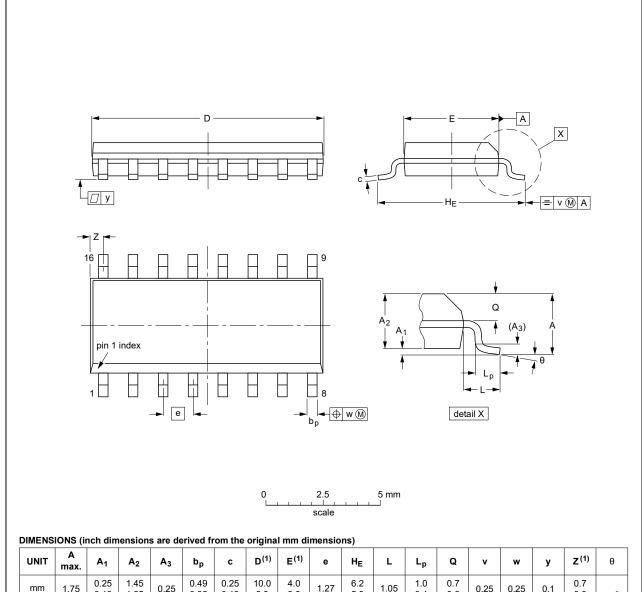
# 11. Application information



# 12. Package outline



SOT109-1



| UNIT   | A<br>max. | <b>A</b> <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С                | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE             | L     | Lp             | Q              | v    | w    | у     | Z <sup>(1)</sup> | θ  |
|--------|-----------|-----------------------|----------------|----------------|--------------|------------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----|
| mm     | 1.75      | 0.25<br>0.10          | 1.45<br>1.25   | 0.25           | 0.49<br>0.36 | 0.25<br>0.19     | 10.0<br>9.8      | 4.0<br>3.8       | 1.27 | 6.2<br>5.8     | 1.05  | 1.0<br>0.4     | 0.7<br>0.6     | 0.25 | 0.25 | 0.1   | 0.7<br>0.3       | 8° |
| inches | 0.069     | 0.010<br>0.004        | 0.057<br>0.049 | 0.01           |              | 0.0100<br>0.0075 | 0.39<br>0.38     | 0.16<br>0.15     | 0.05 | 0.244<br>0.228 | 0.041 | 0.039<br>0.016 | 0.028<br>0.020 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012   | 0° |

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE  |        | REFER  | RENCES | EUROPEAN   | ISSUE DATE                      |  |
|----------|--------|--------|--------|------------|---------------------------------|--|
| VERSION  | IEC    | JEDEC  | JEITA  | PROJECTION | ISSUE DATE                      |  |
| SOT109-1 | 076E07 | MS-012 |        |            | <del>99-12-27</del><br>03-02-19 |  |

Fig. 17. Package outline SOT109-1 (SO16)

#### SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

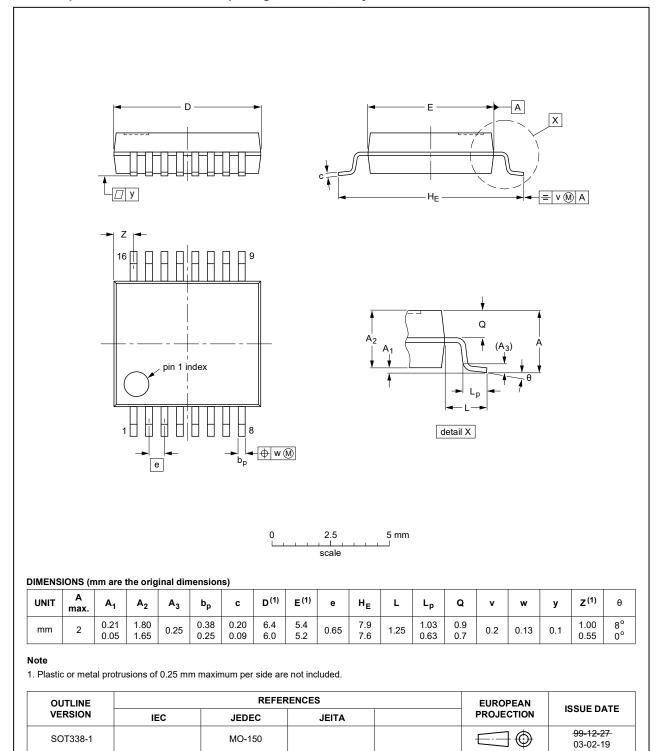
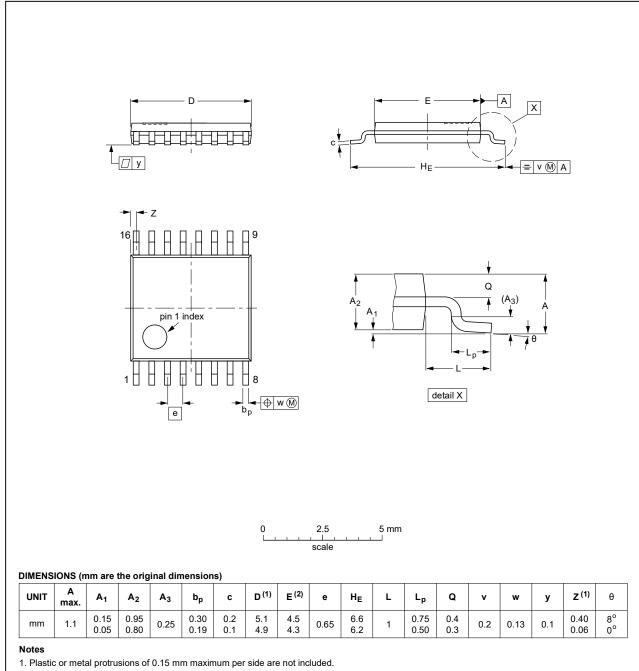


Fig. 18. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  |     | REFER  | RENCES | EUROPEAN   | ISSUE DATE                      |  |
|----------|-----|--------|--------|------------|---------------------------------|--|
| VERSION  | IEC | JEDEC  | JEITA  | PROJECTION | ISSUE DATE                      |  |
| SOT403-1 |     | MO-153 |        |            | <del>99-12-27</del><br>03-02-18 |  |

Fig. 19. Package outline SOT403-1 (TSSOP16)

# 13. Abbreviations

#### **Table 12. Abbreviations**

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal-Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

# 14. Revision history

#### **Table 13. Revision history**

| Document ID         | Release date                       | Data sheet status   | Change notice     | Supersedes          |
|---------------------|------------------------------------|---|-------------------|---------------------|
| 74HC_HCT193 v.6     | 20210205                           | Product data sheet  | -                 | 74HC_HCT193 v.5     |
| Modifications:      | • •                                | r4HC193DB (SOT338-1 / SSO<br>ating values for P <sub>tot</sub> total powe                                     | ,                 | d.                  |
| 74HC_HCT193 v.5     | 20160129                           | Product data sheet  | -                 | 74HC_HCT193 v.4     |
| Modifications:      | Type numbers                       | 74HC193N and 74HCT193N  | (SOT38-4) removed |                     |
| 74HC_HCT193 v.4     | 20130624                           | Product data sheet  | -                 | 74HC_HCT193 v.3     |
| Modifications:      | <ul> <li>General descri</li> </ul> | ption updated.  |                   |                     |
| 74HC_HCT193 v.3     | 20070523                           | Product data sheet  | -                 | 74HC_HCT193_CNV v.2 |
| Modifications:      | guidelines of N • Legal texts hav  | <br>his data sheet has been redes<br>IXP Semiconductors.<br>we been adapted to the new co<br>cation included. |                   | ·                   |
| 74HC_HCT193_CNV v.2 | 19970828                           | Product specification   | -                 | -                   |

### 15. Legal information

#### **Data sheet status**

| Document status [1][2]         | Product<br>status [3] | Definition  |
|--------------------------------|-----------------------|---|
| Objective [short] data sheet   | Development           | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification         | This document contains data from the preliminary specification.                       |
| Product [short]<br>data sheet  | Production            | This document contains the product specification.                                     |

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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74HC\_HCT193

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